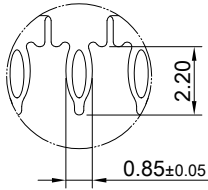
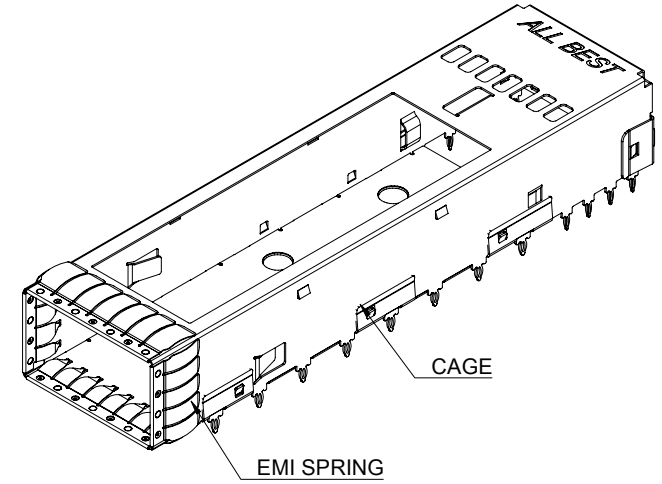
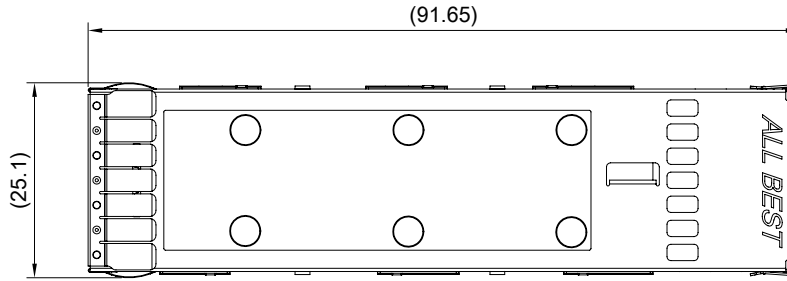


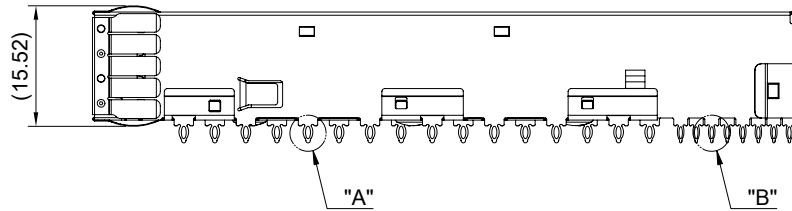
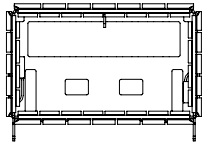
DETAIL A
SCALE 4:1



DETAIL B
SCALE 4:1



MATERIAL
CAGE: NICKEL SILVER
EMI SPRING: STAINLESS STEEL



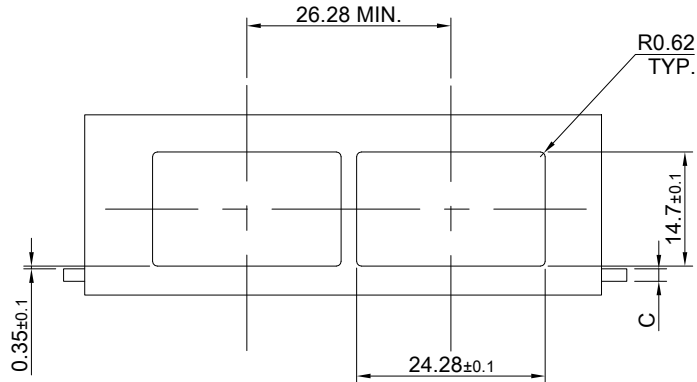
THIS PRINT IS
PRELIMINARY
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BEFORE USING THIS PRINT



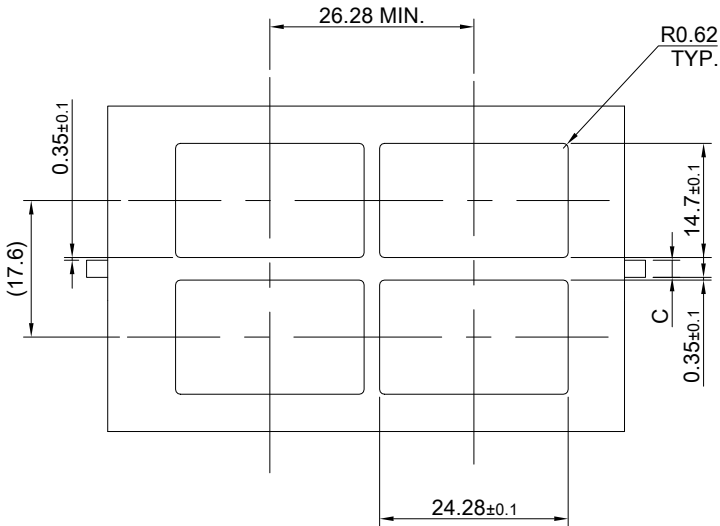
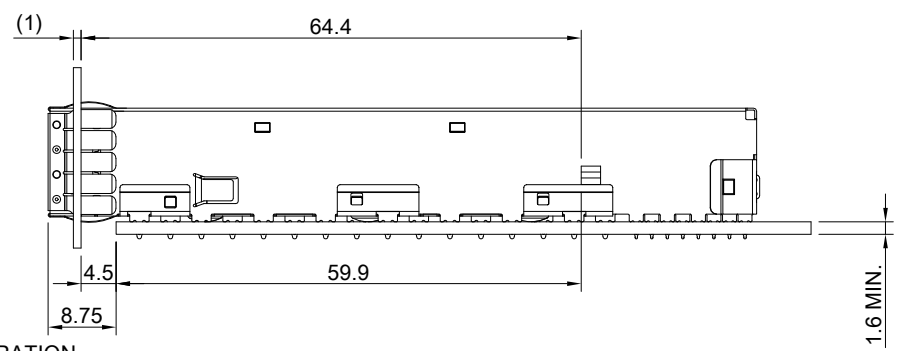
TITLE: OSFP 800 1X1 Cage Assembly			
DWG#: H-OR-DOS1-4CMX6		SHEET: 1/4	REV. REF.
UNIT: mm	SCALE: A4 1:1	FINISH:	CHECKED:
TOLERANCE: X±0.25 .X±0.20 .XX±0.15		MATERIAL: RoHS, HF Compliant	APPROVED:
THIRD ANGLE PROJECTION		DRAWN: Jason Zhao	DATE: 03/21/2024

A B C D E F G H

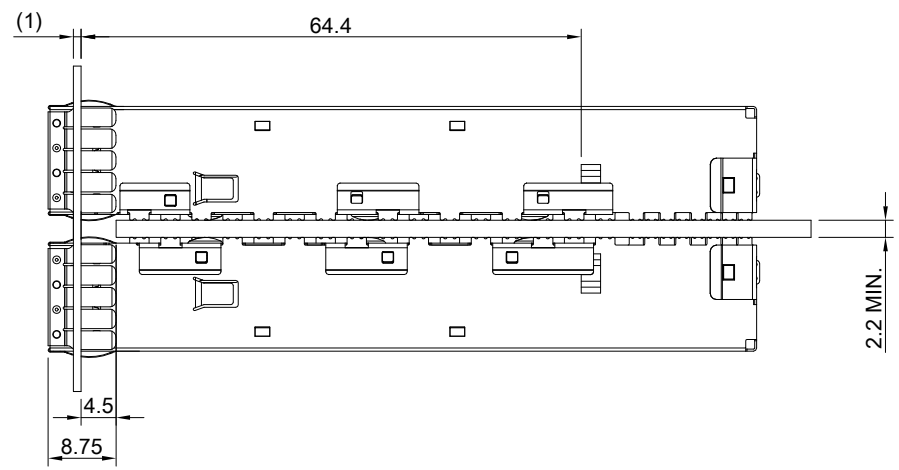
1
2
3
4
5
6
7
8



SINGLE-SIDE CONFIGURATION



BELLY TO BELLY CONFIGURATION



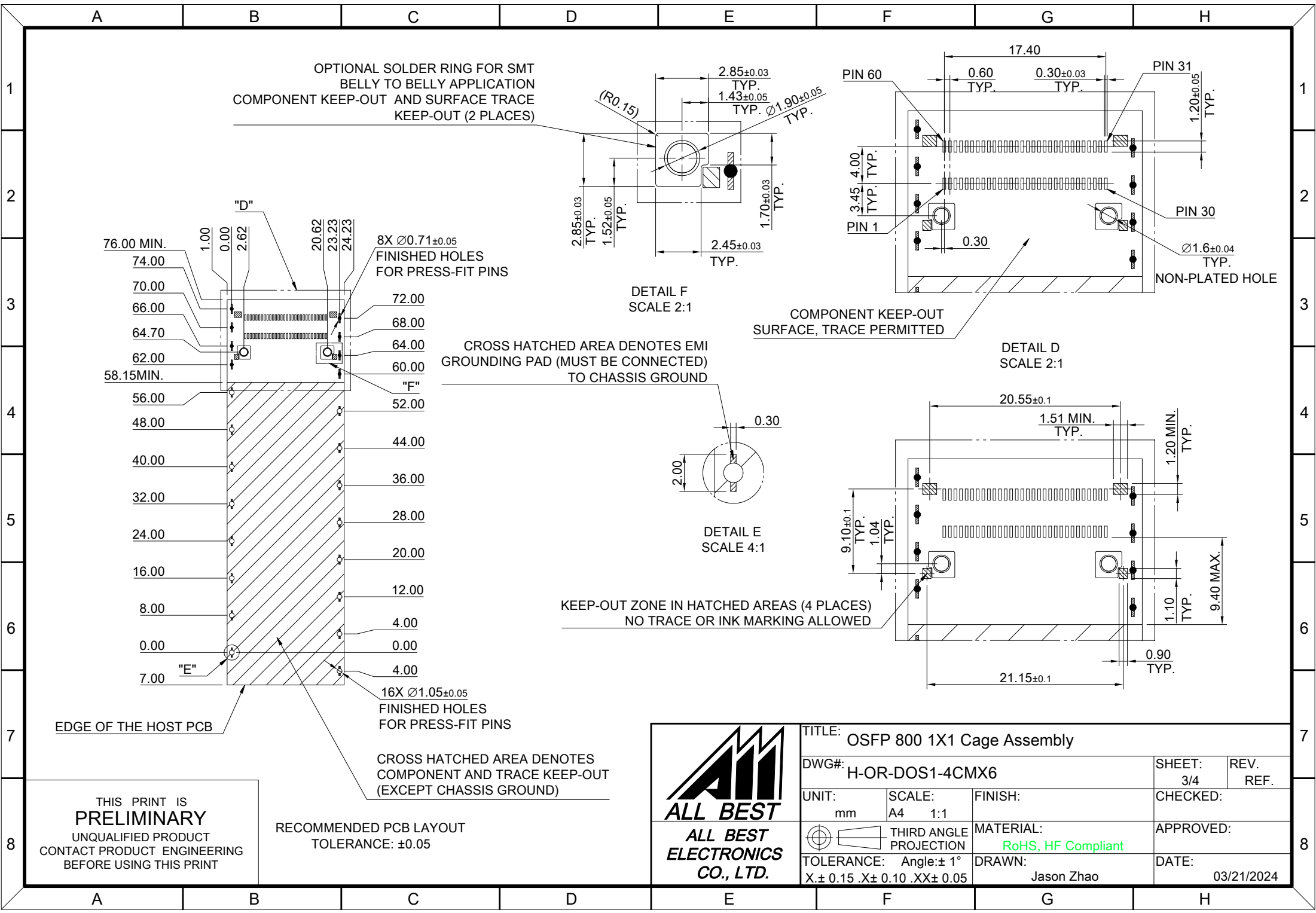
C = THICKNESS OF PC BOARD
 SINGLE-SIDE = 1.6 MM (MIN.)
 BELLY TO BELLY = 2.2MM (MIN.)

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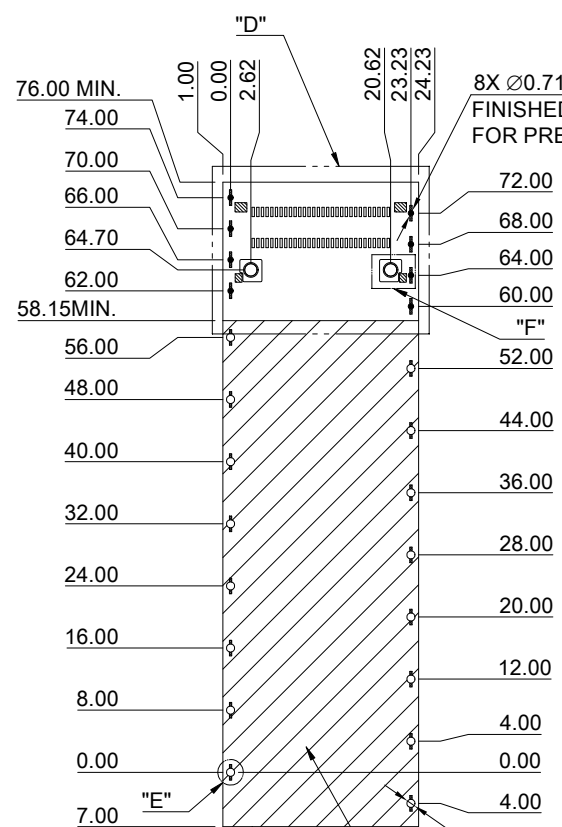
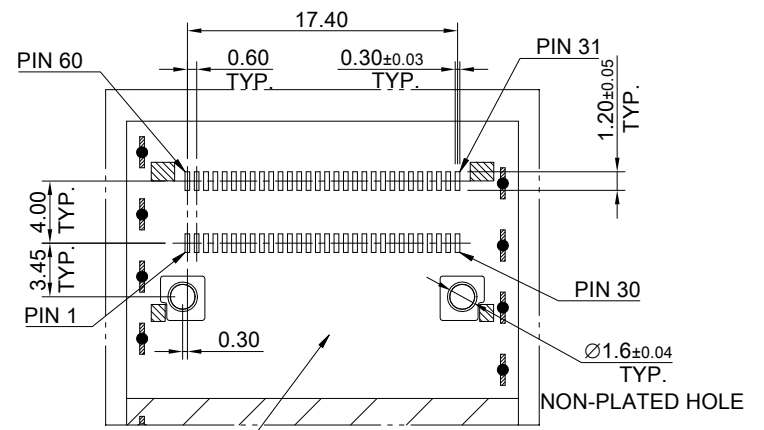
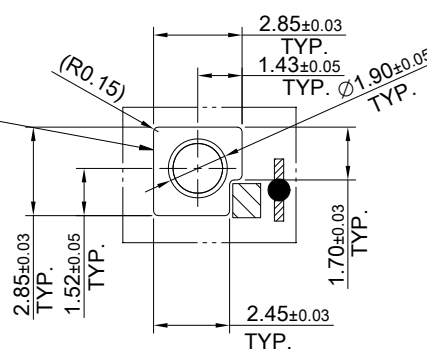


TITLE: OSFP 800 1X1 Cage Assembly			
DWG#: H-OR-DOS1-4CMX6		SHEET: 2/4	REV. REF.
UNIT: mm	SCALE: A4 1:1	CHECKED:	
THIRD ANGLE PROJECTION		APPROVED:	
TOLERANCE: Angle: ± 1°		MATERIAL: RoHS, HF Compliant	DATE: 03/21/2024
X.± 0.15 .X± 0.10 .XX± 0.05		DRAWN: Jason Zhao	

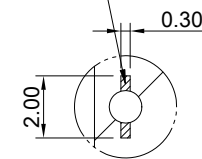
A B C D E F G H



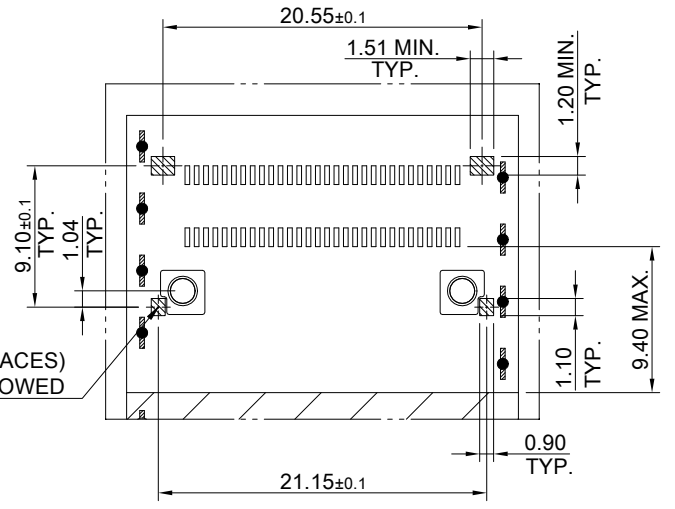
OPTIONAL SOLDER RING FOR SMT BELLY TO BELLY APPLICATION
COMPONENT KEEP-OUT AND SURFACE TRACE KEEP-OUT (2 PLACES)



CROSS HATCHED AREA DENOTES EMI GROUNDING PAD (MUST BE CONNECTED TO CHASSIS GROUND)



KEEP-OUT ZONE IN HATCHED AREAS (4 PLACES)
NO TRACE OR INK MARKING ALLOWED



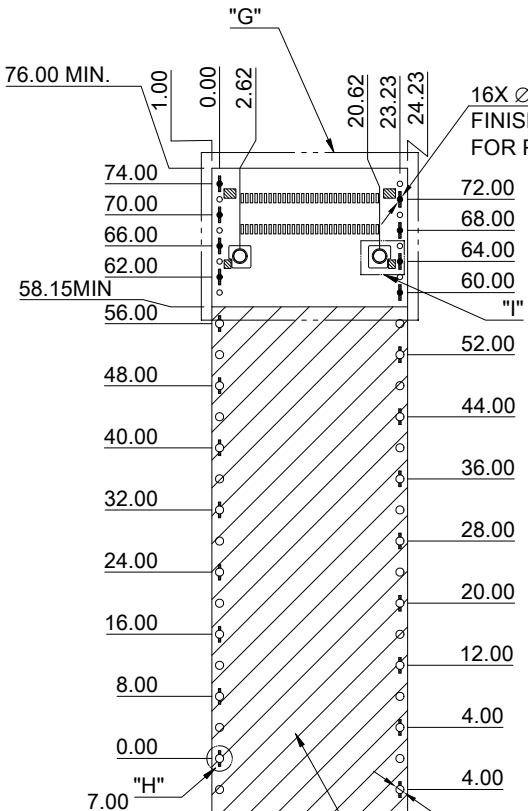
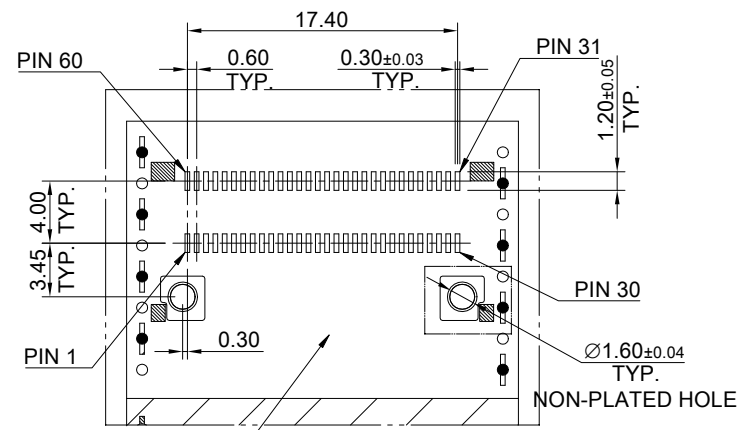
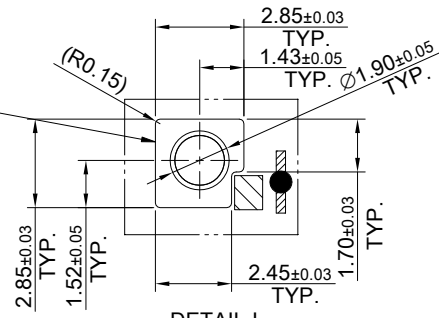
CROSS HATCHED AREA DENOTES COMPONENT AND TRACE KEEP-OUT (EXCEPT CHASSIS GROUND)

RECOMMENDED PCB LAYOUT TOLERANCE: ±0.05

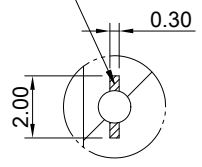
THIS PRINT IS PRELIMINARY
UNQUALIFIED PRODUCT
CONTACT PRODUCT ENGINEERING
BEFORE USING THIS PRINT

	TITLE: OSFP 800 1X1 Cage Assembly		SHEET: 3/4	REV. REF.
	DWG#: H-OR-DOS1-4CMX6		CHECKED:	APPROVED:
	UNIT: mm	SCALE: A4 1:1	MATERIAL: RoHS, HF Compliant	DATE: 03/21/2024
	TOLERANCE: Angle: ±1° X.± 0.15 .X± 0.10 .XX± 0.05		DRAWN: Jason Zhao	

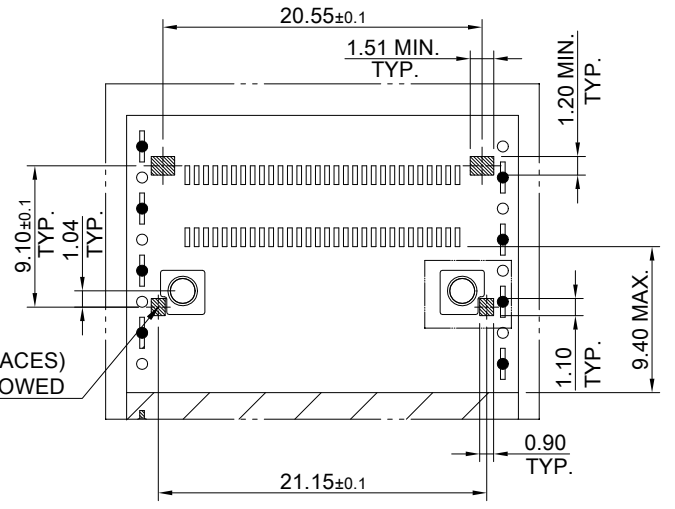
OPTIONAL SOLDER RING FOR SMT BELLY TO BELLY APPLICATION
COMPONENT KEEP-OUT AND SURFACE TRACE KEEP-OUT (2 PLACES)



CROSS HATCHED AREA DENOTES EMI GROUNDING PAD (MUST BE CONNECTED) TO CHASSIS GROUND



KEEP-OUT ZONE IN HATCHED AREAS (4 PLACES)
NO TRACE OR INK MARKING ALLOWED



CROSS HATCHED AREA DENOTES COMPONENT AND TRACE KEEP-OUT (EXCEPT CHASSIS GROUND)

EDGE OF THE HOST PCB

32X $\varnothing 1.05 \pm 0.05$ FINISHED HOLES FOR PRESS-FIT PINS

RECOMMENDED PCB LAYOUT TOLERANCE: ± 0.05

THIS PRINT IS PRELIMINARY
UNQUALIFIED PRODUCT CONTACT PRODUCT ENGINEERING BEFORE USING THIS PRINT



TITLE: OSFP 800 1X1 Cage Assembly			
DWG#: H-OR-DOS1-4CMX6		SHEET: 4/4	REV. REF.
UNIT: mm	SCALE: A4 1:1	CHECKED:	
THIRD ANGLE PROJECTION		APPROVED:	
TOLERANCE: Angle: $\pm 1^\circ$		MATERIAL: RoHS, HF Compliant	DATE: 03/21/2024
X. ± 0.15 .X ± 0.10 .XX ± 0.05		DRAWN: Jason Zhao	